

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2736918

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>DOREEN CHENG</td> <td>02/14/2014</td> </tr> <tr> <td>JIE BAO</td> <td>02/20/2014</td> </tr> <tr> <td>JUSTIN MARTINEAU</td> <td>02/14/2014</td> </tr> <tr> <td>YUNSON MENG</td> <td>02/14/2014</td> </tr> </tbody> </table>		Name	Execution Date	DOREEN CHENG	02/14/2014	JIE BAO	02/20/2014	JUSTIN MARTINEAU	02/14/2014	YUNSON MENG	02/14/2014
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<table border="1"> <tr> <td>Name:</td> <td>SAMSUNG ELECTRONICS CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>129, SAMSUNG-RO, YEONGTONG-GU</td> </tr> <tr> <td>City:</td> <td>SUWON-SI, GYEONGGI-DO</td> </tr> <tr> <td>State/Country:</td> <td>KOREA, REPUBLIC OF</td> </tr> <tr> <td>Postal Code:</td> <td>443-742</td> </tr> </table>		Name:	SAMSUNG ELECTRONICS CO., LTD.	Street Address:	129, SAMSUNG-RO, YEONGTONG-GU	City:	SUWON-SI, GYEONGGI-DO	State/Country:	KOREA, REPUBLIC OF	Postal Code:	443-742
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
<p>Fax Number:</p> <p>Phone: 408-512-1907</p> <p>Email: Efs@ipinvestlaw.com</p> <p><i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i></p> <p>Correspondent Name: INTELLECTUAL PROPERTY INVESTMENT LAW GRO</p> <p>Address Line 1: 3150 DE LA CRUZ BLVD.</p> <p>Address Line 2: SUITE 206</p> <p>Address Line 4: SANTA CLARA, CALIFORNIA 95054</p>											
ATTORNEY DOCKET NUMBER:	48-214										
NAME OF SUBMITTER:	STANLEY CHANG										

Signature:	/Stanley Chang/
Date:	02/21/2014
	This document serves as an Oath/Declaration (37 CFR 1.63).
<b>Total Attachments: 4</b> source=48-214 Executed Declaration-Assignment#page1.tif source=48-214 Executed Declaration-Assignment#page2.tif source=48-214 Executed Declaration-Assignment#page3.tif source=48-214 Executed Declaration-Assignment#page4.tif	


**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET  
(37 CFR 1.76) AND ASSIGNMENT**

SISA Ref No.: ATL11-NP03-B ; IPILG Ref No.: 48-214

<b>Title of Invention</b>	<b>COMPUTING SYSTEM WITH ITERATIVE KNOWLEDGE MANAGEMENT MECHANISM AND METHOD OF OPERATION THEREOF</b>
As the undersigned inventor, I hereby declare that:	
This combined declaration and assignment is directed to:	<input type="checkbox"/> The attached application, or <input checked="" type="checkbox"/> United States application or PCT International application number <u>14/186,309</u> filed on <u>February 21, 2014</u> .
The above-identified application was made or authorized to be made by me.	
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.	
I have reviewed and understand the contents of the application including the claims, for which this combined declaration and assignment is being submitted.	
I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.	
WHEREAS, <u>Samsung Electronics Co., Ltd., a Korean corporation, having a place of business at 129, Samsung-ro, Yeongtong-gu Suwon-si, Gyeonggi-do, Korea</u> (hereinafter referred to as "ASSIGNEE"), desires to acquire the entire right, title and interest in said invention and to any patent that may be granted thereon in the United States and foreign countries;	
NOW, THEREFORE, for good and valuable consideration, the receipt whereof is hereby acknowledged, We, the below named inventors, hereby sell, assign and transfer to said ASSIGNEE, its successors and assigns, the entire right, title and interest in the above-identified application and the invention disclosed therein in all countries, including all divisional applications, continuation applications, and corresponding priority applications including those to which priority is claimed under the International Convention of Paris including under 35 U.S.C. 119, substitutions, and renewals thereof, and to all patents that may be granted thereon, and all reissues thereof.	
We hereby authorize and request the Patent Office Officials in the United States and all foreign countries to issue patents, when granted, to said ASSIGNEE, its successors and assigns. Further, We agree that said ASSIGNEE, its successors and assigns, may apply for patents for the invention in foreign countries without further authorization from us. Also, We agree to execute all papers and generally to do everything possible to aid said ASSIGNEE, its successors and assigns, in obtaining and enforcing patents for the invention in all countries.	
I hereby acknowledge that any willful false statement made in this combined declaration and assignment is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.	

LEGAL NAME OF FIRST INVENTOR (e.g., full first name, middle initial, last name)

Inventor: Doreen Cheng Date: 2/14/2014

Signature: 

LEGAL NAME OF SECOND INVENTOR (e.g., full first name, middle initial, last name)

Inventor: Jie Bao Date: \_\_\_\_\_

Signature: \_\_\_\_\_

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The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application including the claims, for which this combined declaration and assignment is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation, having a place of business at 129, Samsung-ro, Yeongtong-gu Suwon-si, Gyeonggi-do, Korea (hereinafter referred to as "ASSIGNEE"), desires to acquire the entire right, title and interest in said invention and to any patent that may be granted thereon in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration, the receipt whereof is hereby acknowledged, We, the below named inventors, hereby sell, assign and transfer to said ASSIGNEE, its successors and assigns, the entire right, title and interest in the above-identified application and the invention disclosed therein in all countries, including all divisional applications, continuation applications, and corresponding priority applications including those to which priority is claimed under the International Convention of Paris including under 35 U.S.C. 119, substitutions, and renewals thereof, and to all patents that may be granted thereon, and all reissues thereof.

We hereby authorize and request the Patent Office Officials in the United States and all foreign countries to issue patents, when granted, to said ASSIGNEE, its successors and assigns. Further, We agree that said ASSIGNEE, its successors and assigns, may apply for patents for the invention in foreign countries without further authorization from us. Also, We agree to execute all papers and generally to do everything possible to aid said ASSIGNEE, its successors and assigns, in obtaining and enforcing patents for the invention in all countries.

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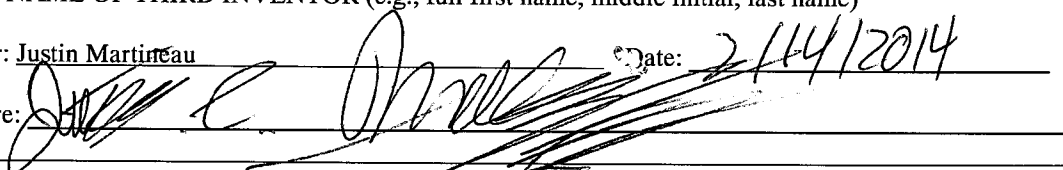
<b>LEGAL NAME OF FIRST INVENTOR (e.g., full first name, middle initial, last name)</b>	
Inventor: <u>Doreen Cheng</u>	Date: _____
Signature: _____	

<b>LEGAL NAME OF SECOND INVENTOR (e.g., full first name, middle initial, last name)</b>	
Inventor: <u>Jie Bao</u>	Date: <u>2014-02-20</u>
Signature: <u>Jie Bao</u>	

LEGAL NAME OF THIRD INVENTOR (e.g., full first name, middle initial, last name)

Inventor: Justin Martineau

Date: 2/14/2014

Signature: 

LEGAL NAME OF FOURTH INVENTOR (e.g., full first name, middle initial, last name)

Inventor: Yunson Meng

Date: \_\_\_\_\_

Signature: \_\_\_\_\_

PATENT

REEL: 032268 FRAME: 0937

LEGAL NAME OF THIRD INVENTOR (e.g., full first name, middle initial, last name)

Inventor: Justin Martineau Date: \_\_\_\_\_

Signature: \_\_\_\_\_

LEGAL NAME OF FOURTH INVENTOR (e.g., full first name, middle initial, last name)

Inventor: Yunson Meng Date: 02/14/14

Signature: 